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NCE 60V Complementary MOSFET

Description

The NCE60NP09S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

N channel

V_{DS} =60V,I_D =9A
R_{DS(ON)} <28mΩ @ V_{GS}=10V
R_{DS(ON)} <34mΩ @ V_{GS}=4.5V

p channel

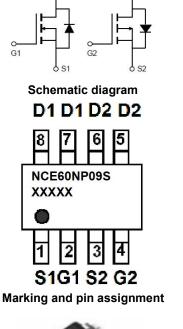
• V_{DS} =-60V,I_D =-9A

 $R_{DS(ON)}$ <54m Ω @ V_{GS}=-10V

- $R_{\text{DS(ON)}} <\!\!70m\Omega \textcircled{0} V_{\text{GS}} = \!\!-4.5 V$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- H-bridge
- Inverters





SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60NP09S	NCE60NP09S	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25°Cunless otherwise noted)

Param	Symbol	N-Channel	P-Channel	Unit V V	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	60		-60
		V _{GS}	±20		±20
Orational Durin Oranat	Tc=25℃		9	-9	А
Continuous Drain Current	Tc=100℃	ID ID	6.3	-6.3	
Pulsed Drain Current (Note 1)		IDM	36	-36	А
Maximum Power Dissipation	Tc=25℃	PD	3	3	W
Operating Junction and Storage Temperature Range		TJ,TSTG	-55 To 150	-55 To 150	°C

Thermal Characteristic

N-channel	Thermal Resistance, Junction-to- Ambient (Note 2)	R _{0JA}	41.67	°C/W
P-channel	Thermal Resistance, Junction-to- Ambient (Note 2)	R _{0JA}	41.67	°C/W
N-channel	Thermal Resistance, Junction-to- Lead (Note 2)	$R_{\theta JL}$	20	°C/W
P-channel	Thermal Resistance, Junction-to- Lead (Note 2)	$R_{\theta JL}$	20	°C/W



N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			·			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.0	1.6	2.5	V
	R _{DS(ON)}	V _{GS} =10V, I _D =5A	-	24	28	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =5A		28	34	mΩ
Forward Transconductance	g⊧s	V _{DS} =5V,I _D =5A	11	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	Clss		-	846	-	PF
Output Capacitance	Coss	$V_{DS}=30V, V_{GS}=0V,$	-	65	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	61.8	-	PF
Switching Characteristics (Note 4)	I					
Turn-on Delay Time	t _{d(on)}		-	4.2	-	nS
Turn-on Rise Time	tr	V _{DD} =30V ,R _L =2.5Ω	-	3.4	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	16	-	nS
Turn-Off Fall Time	t _f		-	2	-	nS
Total Gate Charge	Qg	N/ 001/1 51	-	25		nC
Gate-Source Charge	Qgs	V_{DS} =30V,I _D =5A,	-	3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6.4		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =5A	-		1.2	V
Diode Forward Current (Note 2)	ls		-	-	5	A
Reverse Recovery Time	trr	TJ = 25°C, IF =5A	-	27	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	30	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LI				
	1					

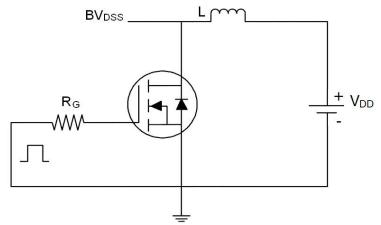
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C. The value in any a given application depends on the user's specific board design. The $R_{\theta JA}$ i is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

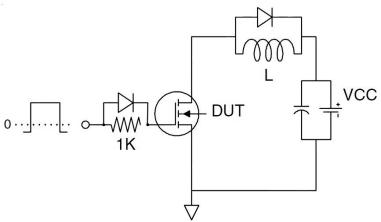


Test Circuit

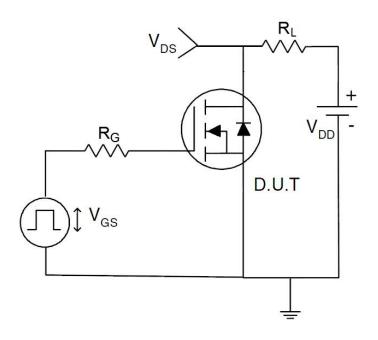
1) E_{AS} test Circuit



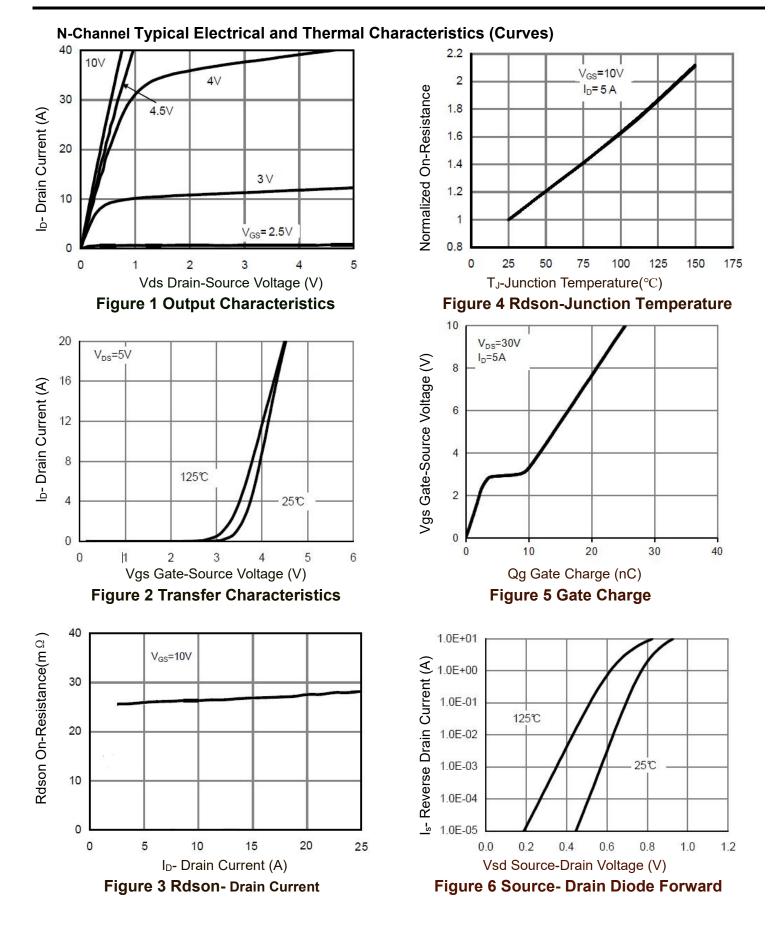
2) Gate charge test Circuit



3) Switch Time Test Circuit





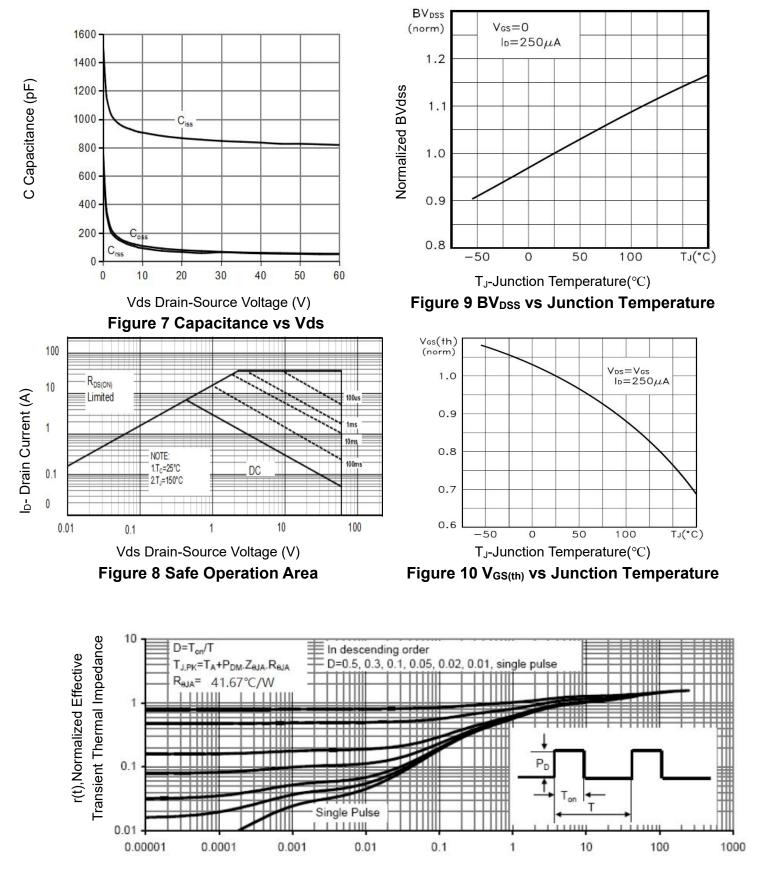


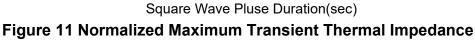
Wuxi NCE Power Co., Ltd



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NCE60NP09S







P-Channel Electrical Characteristics (Tc=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	I					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	I					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=-250\mu A$	-1	-1.5	-2.2	V
	D	V _{GS} =-10V, I _D =-5A	-	45	54	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-5A		52	70	mΩ
Forward Transconductance	g Fs	V _{DS} =-5V,I _D =-5A	-	10	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	Clss	<u>)</u>	-	1630.7	-	PF
Output Capacitance	Coss	V _{DS} =-30V,V _{GS} =0V, F=1.0MHz	-	90.6	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHZ	-	77.3	-	PF
Switching Characteristics (Note 4)	· · ·		•			
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	tr	V_{DD} =-30V, R _L =1.5 Ω ,	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{G} =3 Ω	-	33	-	nS
Turn-Off Fall Time	t _f		-	13	-	nS
Total Gate Charge	Qg	V _{DS} =-30,I _D =-5A,	-	37.6		nC
Gate-Source Charge	Q _{gs}		-	4.3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7.2		nC
Drain-Source Diode Characteristics	····					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-5A	-		-1.2	V
Diode Forward Current (Note 2)	ls		-	-	-7	A
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-5A	-	35	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	38	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				

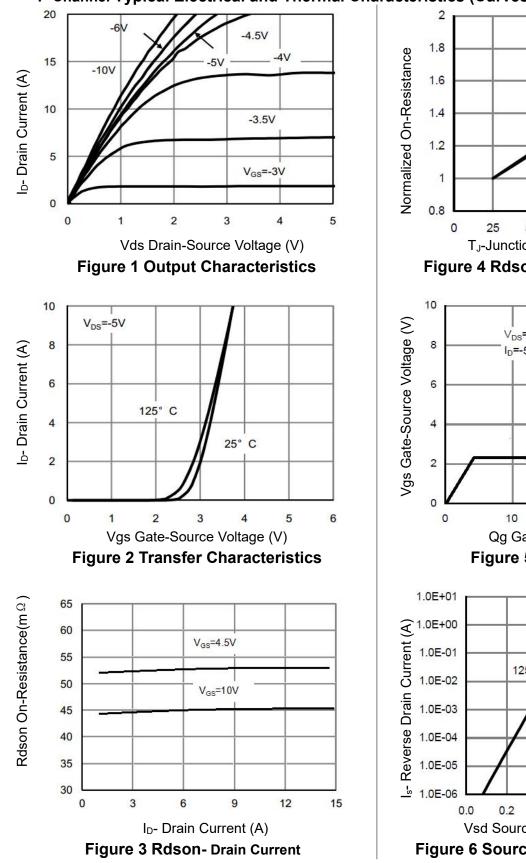


V_{GS}=-4.5V

ID=-24

V_{GS}=-10V

I_D=-5A



P-Channel Typical Electrical and Thermal Characteristics (Curves)

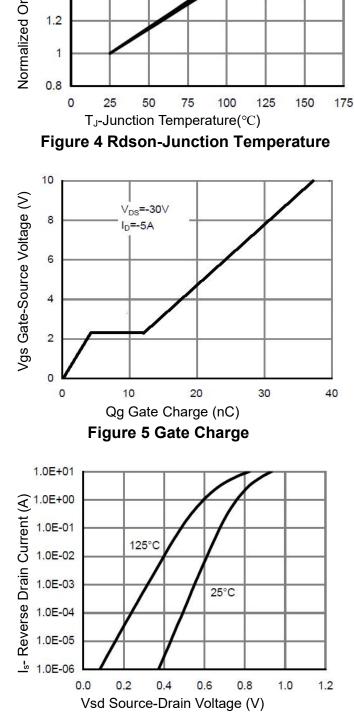
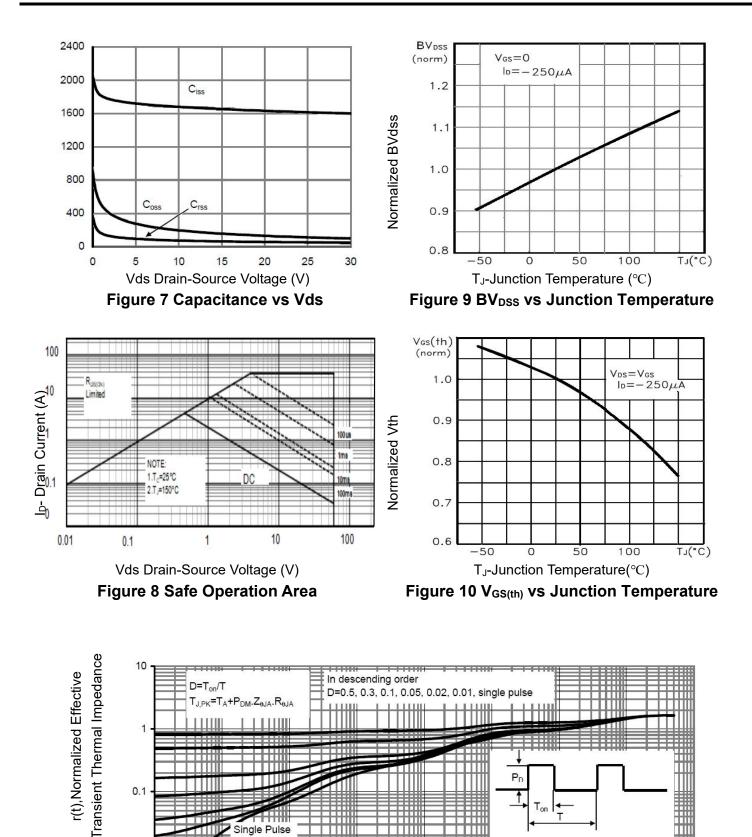


Figure 6 Source- Drain Diode Forward



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0.1

Pr

1

Ton

10

100

0.1

0.01

0.00001

ттп

0.0001

Single Pulse 11110

0.001

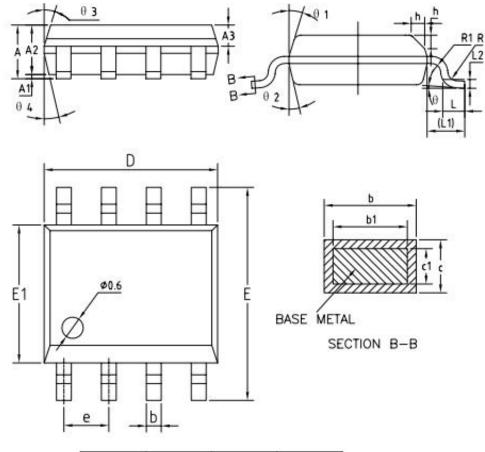
0.01

1000



2

SOP-8 Package Information



SYMBOL	MIN	NOM	MAX	
A	1.35	1.55	1.75	
A1	0.10	0.15	0.25	
A2	1.25	1.40	1.65	
A3	0.50	0.60	0.70	
b	0.38	_	0.51	
b1	0.37	0.42	0.47	
с	0.18	-	0.25	
c1	0.17	0.20	0.23	
D	4.80	4.90	5.00	
E	5.80	6.00	6.20	
E1	3.80	3.90	4.00	
e	1.17	1.27	1.37	
e L	0.45	0.60	0.80	
L1		1.04REF		
L2	0.25BSC			
R	0.07	-		
R1	0.07	· - ·	\$ = 5	
h	0.30	0.40	0.50	
θ	0"	_	8'	
θ 1	15*	17	19"	
θ2	11.	13	15'	
θ3	15	17	19"	
θ4	11.	13	15'	



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